

## DLP® Ultra-mobile Near-Infrared Spectrometer with Bluetooth Connectivity

### **About Test Results**

The DLP Ultra-mobile Near-Infrared (NIR) Spectrometer reference design utilizes Texas Instruments' DLP technology in conjunction with a single-element InGaAs detector to deliver high performance measurements in a portable form factor that is more affordable than expensive InGaAs array detector or fragile rotating grating architectures. This design features multiple TI components, highlighted by the DLP2010NIR Digital Micromirror Device, DLPC150 Digital Controller, and DLPA2005 Power Management.

The reference design includes compact battery-operated architecture, supports Bluetooth low energy for wireless connectivity, and TI Tiva processor to leverage cloud databases for real-time lab equivalent analytics.

The spectrum data contained below was measured from one DLP NIRscan™ Nano evaluation module (EVM) to provide an example from a typical unit. The spectrum data was acquired using the EVM's Line Scan, which was configured for 248 data points across a wavelength range of 900 nm to 1700nm and captured with a 1s total scan time. Please note performance will vary between EVMs due to variations in manufacturing and reference spectra from the user's catalog of spectral characteristics. The performance data is not guaranteed.



**DLP NIRscan Nano Evaluation Module** 

## **Related Documentation From Texas Instruments**

DLPC150 Data Sheet: DLP Digital Controller for Advanced Light Control, TI literature number DLPS048A

DLP2010NIR Data Sheet: 0.2 WVGA Near-Infrared DMD, TI literature number DLPS059

Programmer's Guide: DLPC150 Programmer's Guide User's Guide, DLPU031

Application Note: *DLP®* for Spectroscopy, TI literature number <u>DLPA049</u>

Selection Guide: DLP® Products for Spectroscopy, TI literature number DLPT020

### If You Need Assistance

Refer to the <u>DLP and MEMS TI E2E Community support forums</u>

# Spectrum Analysis

This chapter provides test data of wavelength absorbance spectrums from eight commercially available samples.

When a spectrum is captured, the output can potentially be used to:

- Identify an unknown material by comparison to a catalog of spectral characteristics
- Determine the presence of a substance of interest
- Inspect a quantity of material to determine concentration limits of certain substances
- Analyze the chemical composition of a sample using PCA (Principal Component Analysis) and Chemometrics

To measure the absorbance of such samples, the following procedure is used on a system with the DLP® NIRscan™ Nano GUI installed:

### Make Reference Scan in the NIRscan™ Nano GUI:

- 1. Click on the "New/Edit/Export/Import" button in the Scan control box to invoke the Scan Configuration dialog box.
- 2. The Scan Configuration dialog boxhas three sections:
  - The top left section displays previous scan configurations saved to the PC.
  - The top right section displays the scan configurations saved on the DLP NIRscan Nano EVM.
  - The bottom section displays the scan configuration parameters of the selected PC or DLP NIRscan Nano EVM stored scan configuration.
- 3. Click New button on the top left section of the Scan Configuration dialog. Then type the desired spectral range between 900 and 1700 nm.
- 4. Select the width in nm that corresponds to the smallest wavelength content that you want to resolve.
- 5. Enter the desired number of wavelength points captured across the spectral range.
- 6. Enter the Number of scans to average for corresponding back-to-back scans to average.
- 7. Enter a configuration name and click save.
- 8. Close the Scan Configuration dialog by clicking OK.

### Take Sample Scan:

Once a scan configuration is selected, define a reference by scanning a reflective reference standard. Then click on the Set as Reference button. After these steps, scanning any sample will allow the plot of absorbance.

To display previous scans, click on the "scans" button under the Texas Instruments logo. A sub-window will pop up displaying the previous scans stored in the PC. The files are stored with the name of the scan configuration appended with the date and time of the scan. Selecting one of the files and clicking on the "Display spectrum" plots that file. Click on the "hide" button to hide this sub-window.

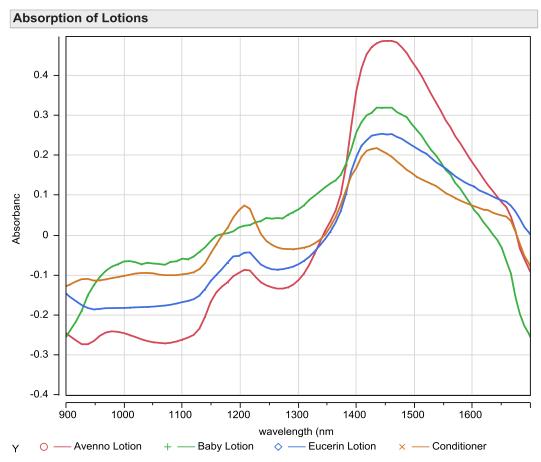


Figure 1. Wavelength Absorbance Spectrum Comparison of Brand Moisturizers on Skin

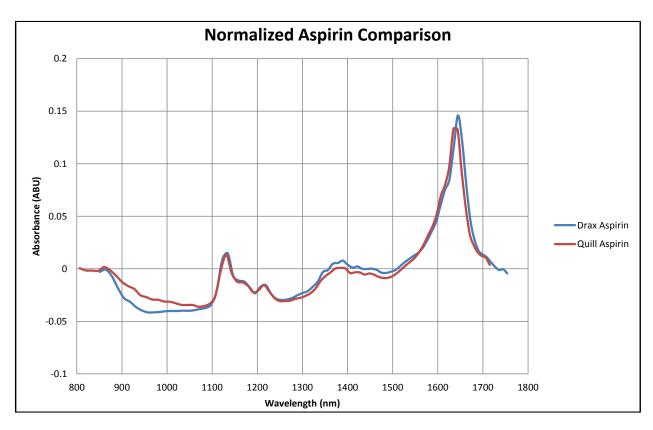


Figure 2. Wavelength Absorbance Spectrum Comparison of Drax Aspirin and Quill Aspirin

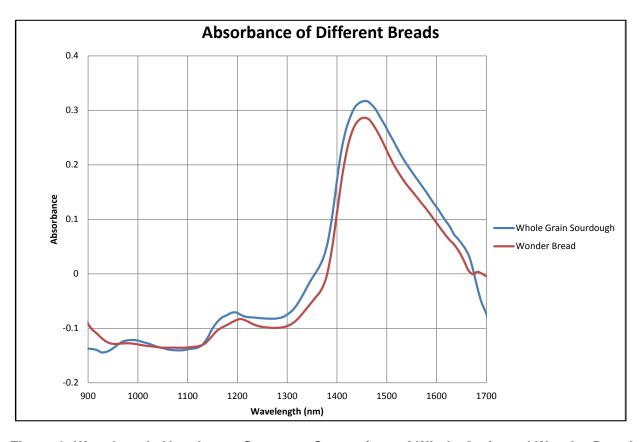


Figure 3. Wavelength Absorbance Spectrum Comparison of Whole Grain and Wonder Bread

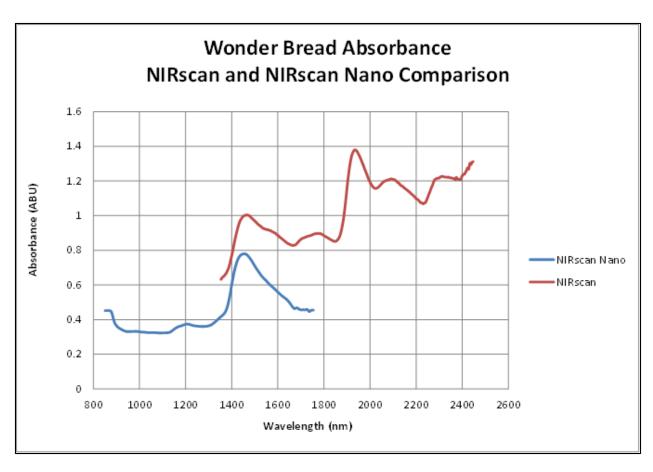


Figure 4. NIRscan and NIRscan Nano Wavelength Absorbance Spectrum Comparison

### IMPORTANT NOTICE FOR TI REFERENCE DESIGNS

Texas Instruments Incorporated ("TI") reference designs are solely intended to assist designers ("Buyers") who are developing systems that incorporate TI semiconductor products (also referred to herein as "components"). Buyer understands and agrees that Buyer remains responsible for using its independent analysis, evaluation and judgment in designing Buyer's systems and products.

TI reference designs have been created using standard laboratory conditions and engineering practices. TI has not conducted any testing other than that specifically described in the published documentation for a particular reference design. TI may make corrections, enhancements, improvements and other changes to its reference designs.

Buyers are authorized to use TI reference designs with the TI component(s) identified in each particular reference design and to modify the reference design in the development of their end products. HOWEVER, NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY THIRD PARTY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT, Is GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI REFERENCE DESIGNS ARE PROVIDED "AS IS". TI MAKES NO WARRANTIES OR REPRESENTATIONS WITH REGARD TO THE REFERENCE DESIGNS OR USE OF THE REFERENCE DESIGNS, EXPRESS, IMPLIED OR STATUTORY, INCLUDING ACCURACY OR COMPLETENESS. TI DISCLAIMS ANY WARRANTY OF TITLE AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, QUIET ENJOYMENT, QUIET POSSESSION, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS WITH REGARD TO TI REFERENCE DESIGNS OR USE THEREOF. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY BUYERS AGAINST ANY THIRD PARTY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON A COMBINATION OF COMPONENTS PROVIDED IN A TI REFERENCE DESIGN. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, SPECIAL, INCIDENTAL, CONSEQUENTIAL OR INDIRECT DAMAGES, HOWEVER CAUSED, ON ANY THEORY OF LIABILITY AND WHETHER OR NOT TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES, ARISING IN ANY WAY OUT OF TI REFERENCE DESIGNS OR BUYER'S USE OF TI REFERENCE DESIGNS.

TI reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques for TI components are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

Reproduction of significant portions of TI information in TI data books, data sheets or reference designs is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards that anticipate dangerous failures, monitor failures and their consequences, lessen the likelihood of dangerous failures and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in Buyer's safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed an agreement specifically governing such use.

Only those TI components that TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components that have *not* been so designated is solely at Buyer's risk, and Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.